

Carrier Material Report for DS90CF386SLC/NOPB

Tray Information:

| L - Outer tray length without tabs | , _− KO - I 1 Outer | | | | | | | | | |
|---|------------------------|--|--|--|--|--|--|--|--|--|
| $\begin{bmatrix} + + + + + + + + + + + + + + + + + + +$ | tray height | | | | | | | | | |
| P1 - Tray unit pocket pitch CW - Measurement for tray edge (Y direction) to corner pocket center CL - Measurement for tray edge (X direction) to corner pocket center | | | | | | | | | | |

| Device | Package | Package | Pins | SPQ | Unit | Max | L (mm) | W (mm) | K0 (µm) | P1 (mm) | CL (mm) | CW |
|--------|---------|---------|------|-----|---------|------|--------|--------|---------|---------|---------|-------|
| | Drawing | Туре | | | Array | Temp | | | | | | (mm) |
| | | | | | Matrix | (°C) | | | | | | |
| DS90C | NZC | NFBGA | 64 | 360 | 12 x 30 | 150 | 322.6 | 135.9 | 7620 | 10 | 12.5 | 12.95 |
| F386SL | | | | | | | | | | | | |
| C/NOPB | | | | | | | | | | | | |

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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